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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:

Itsuo WATANABE et al.

Serial No. 09/402,274

Filed: December 16, 1999

For: CIRCUIT-CONNECTING MATERIAL  
AND CIRCUIT TERMINAL CON-  
NECTED STRUCTURE etc.



) Atty. Docket: TM&K0013

) Group Art Unit: 1714

) Examiner:

) Date: June 21, 2001

INFORMATION DISCLOSURE STATEMENT

Assistant Commissioner for Patents  
Washington, D. C. 20231

Sir:

This is an Information Disclosure Statement with regard to the above-identified application.

Copies of each of the documents listed in the attached Form PTO/SB/08A are attached.

Document A relates to a method of using an anisotropically electroconductive adhesive having pressure-deformable electroconductive particles to electrically connect circuits. Document B relates to anisotropic conductive adhesive compositions. Document C relates to an anisotropically electroconductive adhesive and adhesively bonded structure therewith. Their relevance is believed to be clear from the disclosure in each. Accordingly, no further comment in regard to the disclosures of these documents is believed to be required.

It is respectfully requested that the attached documents be considered and officially cited, and that a copy of the Form PTO/SB/08A, initialed by the Examiner to indicate that the documents have been considered, be returned to the applicants.

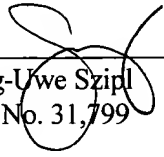
It is believed that the present Information Disclosure Statement complies with the requirements

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of 37 C.F.R. §§ 1.97-8, but if a fee should be required, authorization is hereby given to deduct from deposit account No. 50-1281.

Respectfully submitted,

GRIFFIN & SZIPL, PC

  
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Joerg-Uwe Szimpl  
Reg. No. 31,799

GRIFFIN & SZIPL, PC  
Suite PH-1  
2300 Ninth Street, South  
Arlington, VA 22204

Telephone: (703) 979-5700  
Facsimile: (703) 979-7429  
Customer No.: 24203

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